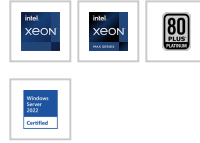


R263-S30 (rev. AAC1) | (rev.AAC2) | (rev.AAH1) | (rev.AAH2)

Rack Server - 4th Gen Intel® Xeon® - 2U UP 12-Bay NVMe/SATA/SAS | Application: **Networking**

- 4th Gen Intel® Xeon® Scalable Processors
- Intel® Xeon® CPU Max Series
- Single processor, LGA 4677
- 8-Channel RDIMM DDR5 per processor, 16 x DIMMs
- Dual ROM Architecture
- 1 x 1Gb/s LAN port (Intel® I210-AT)
- 1 x Dedicated management port
- 4 x 3.5"/2.5" Gen4 NVMe/SATA/SAS hot-swappable bays
- 8 x 3.5"/2.5" SATA/SAS hot-swappable bays
- 1 x M.2 slot with PCIe Gen3 x4 interface
- 2 x FHHL PCIe Gen5 x16 slots
- 2 x OCP 3.0 Gen5 x16 slots
- 1+1 1300W (240V) 80 PLUS Platinum redundant power supplies



OVERVIEW SPECIFICATIONS SUPPORT RESOURCES BUY

R263-S30 (rev. AAC1)

Dimensions (WxHxD, mm)

2U
438 x 87.5 x 710

Motherboard

MS33-DC0

CPU

4th Generation Intel® Xeon® Scalable Processors
Intel® Xeon® CPU Max Series
Intel® Xeon® Platinum Processor, Intel® Xeon® Gold Processor, Intel® Xeon® Silver Processor
Single processor, CPU TDP up to 350W

Socket

1 x LGA 4677
Socket E

Chipset

Intel® C741 Chipset

Memory

16 x DIMM slots
DDR5 memory supported only
8-Channel memory architecture
RDIMM modules up to 96GB supported
3DS RDIMM modules up to 256GB supported
Memory speed: Up to 4800 MHz (1DFC), 4400 MHz (2DFC)

LAN

Rear side:
1 x 1Gb/s LAN port (1 x Intel® I210-AT)
Supports NCSI function

1 x 10/100/1000 management LAN

Video

Integrated in Aspeed® AST2600
2D Video Graphic Adapter with PCIe bus interface
1920x1200@60Hz 32bpp, DDR4 SDRAM

Storage

Front side:
4 x 3.5"/2.5" Gen4 NVMe/SATA/SAS hot-swappable bays, NVMe from CPU
8 x 3.5"/2.5" SATA/SAS hot-swappable bays

SAS card is required for SAS devices support

SAS

Depends on SAS Add-on card

RAID

Intel® SATA RAID 0/1/10/5

Expansion Slots

Riser Card CRS201C:
- 1 x PCIe x16 (Gen5 x16) FHHL slot, from CPU

Riser Card CRS201D:
- 1 x PCIe x16 (Gen5 x16) FHHL slot, from CPU

2 x OCP 3.0 slots with PCIe Gen5 x16 bandwidth, from CPU
Support NCSI function

1 x M.2 slot:
- M-key
- PCIe Gen3 x4, from PCH
- Supports 2280/22110 cards

Internal I/O

1 x M.2 slot
1 x TPM header
1 x VROC connector
2 x OCP 3.0 slots

Front I/O

2 x USB 3.2 Gen1
1 x Power button with LED
1 x ID button with LED
1 x NMI button
1 x Reset button
1 x LAN activity LED
1 x HDD activity LED
1 x System status LED

Rear I/O

2 x USB 3.2 Gen1
1 x Mini-DP
1 x RJ45
1 x MLAN
1 x ID button with LED

Backplane I/O

Speed and bandwidth:
PCIe Gen4 x4 or SATA 6Gb/s or SAS 12Gb/s

TPM

1 x TPM header with SPI interface
Optional TPM2.0 kit: [CTM010](#)

Power Supply

1+1 1300W (240V) 80 PLUS Platinum redundant power supplies

AC Input:
- 100-240V~/12-7A, 50-60Hz
- 200-240V~/8A, 50-60Hz

DC Input:
- 240Vdc/6.5A

DC Output:
- Max 1000W/ 100-240V~
+ 12V/ 80.5A
+ 12Vsb/ 3A
- Max 1300W/ 200-240V~ or 240Vdc Input
+ 12V/ 105.4A
+ 12Vsb/ 3A

NOTE: The default power supply is based on a basic system configuration. Please contact with technical representatives to determine the best power supply selection for your system configuration requirements and preferred efficiency.

System Management

Aspeed® AST2600 management controller
GIGABYTE Management Console (AMI MegaRAID SP-X) web interface

Dashboard
HTML5 KVM
Sensor Monitor (Voltage, RPM, Temperature, CPU Status ...etc)
Sensor Reading History Data
FRU Information
SEL Log in Linear Storage / Circular Storage Policy
Hardware Inventory
Fan Profile
System Firewall
Power Consumption
Power Control
Advanced power capping
LDAP / AD / RADIUS Support
Backup & Restore Configuration
Remote BIOS/BMC/CPUD Update
Event Log Filter
User Management
Media Redirection Settings
PAM Order Settings
SSL Settings
SMTP Settings

OS Compatibility

Please refer to OS compatibility table in support page

Additional certifications:
[Windows Server 2022 \(x64\)](#)

System Fans

4 x 80x80x38mm (18,300rpm)

Operating Properties

Operating temperature: 10°C to 35°C
Operating humidity: 8%-80% (non-condensing)
Non-operating temperature: -40°C to 60°C
Non-operating humidity: 20%-95% (non-condensing)

Packaging Dimensions

989 x 594 x 279 mm

Packaging Content

1 x R263-S30
1 x CPU heatsink
1 x Mini-DP to D-Sub cable
3 x Carrier clips
1 x 2-Section Rail kit

Part Numbers

- Barebone package: 6NR263S30DR000AAC1*
- Motherboard: 9MS33DC0UR-000
- 2-Section Rail kit: 25HB2-3A0203-K0R
- CPU heatsink: 25ST1-323208-A0R
- M.2 heatsink: 12SP2-11000E-00R
- Front panel board - CFP2001: 9CFP2001NR-00
- Backplane board - CBP20C5: 9CBP20C5NR-00
- Fan module: 25ST2-88382T-S1R
- Riser card - CRS201C: 9CRS201CNR-00
- Riser card - CRS201D: 9CRS201DNR-00
- Mini-DP to D-Sub cable: 25CRN-200801-K1R
- Power supply: 25EP0-213006-F3S

Optional parts:

- 3-Section Rail kit: 25HB2-A56121-K0R
- Cable Management Arm: 25HB1-R18300-K0R